BONDING THE STARS







Stand Alone Bond-Tester 5600CS

Tester System

Testheads Pullheads – 100cN – 5000 cN

Shearheads - 500cN - 50000 cN

Tweezerhead - 100cN

Tester Base

Axes

- Working area X/Y-axis 100x115mm
- Step resolution 0,25μm
- Repeatability < 2µm

Hardware

- Dual Core PC, 1,6 GHz processor,
- 4 GB RAM, Ethernet, 4x USB-Hub Front
- Firewire CCD colour camera 1,4 MPixel
- Network-capable with TCP / IP server

Software

- Automatic repeat measurements on hybrids or COB using the programmable table movement
- Optional pattern recognition
- Statistics such as mean value, standard deviation, trend, cp, cpk, etc. Based on SQL Databan
- Export Format SQL, CSV, HTML

Speed Test speed from 0.2 to 5mm/s

Dimenstions W x D x H - 70 x 65x 70 cm, weight approx. 80kg

Connections 100-240 VAC, 1 Phase, 50/60 Hz, max 500 VA

Ø 6mm standard vacuum tubing

5600CS:

The automatic bond tester 5600CS complements F&S Bondtec Semiconductor GmbH die- and wire- bonders. The PC controlled moving table allows any number of bonds to be tested automatically from a stored program.

Results can be analysed and output immediately or exported in a number of data base formats for subsequent analysis as desired. Powerful extended capabilities enable measurements such as force/time or force/distance curves to be made and deliver more data about the quality of the bond tested.

Exchangeable measurement cartridges ensure rapid conversion to different force ranges. The calibration curves of all measurement cartridges are stored internally; additional heads for shear, peel and tweezer testing with customer-specific tools and jaws are available.

After a first programming a reproducible pull- or sheartest can be guaranteed for all following components.

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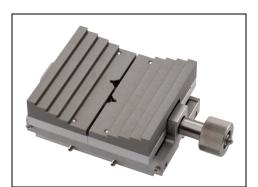


Workholder

Standard-Workholder for parts up to 4x4" with Vacuum und mechanical clamping



Optional:



workholders up to 4x4" with jaws



TO workhoder with mechanical clamping



4x4" workholder with . rubberized surface and mechanical clamping

F&S Bondtec Semiconductor GmbH

Industriezeile 49a

A-5280 Braunau am Inn

Tel.: +43-7722-67052-8270
Fax: +43-7722-67052-8272
Mail: info@fsbondtec.at
Web: www.fsbondtec.at



Ihr Vertriebspartner/ Votre représentant:

Hilpert electronics AG Täfernstrasse 29 5405 Baden-Dättwil Schweiz / Suisse Tel: +41 56 483 25 25 Fax: +41 56 483 25 20 Mail: office@hilpert.ch Web: www.hilpert.ch

